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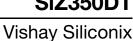
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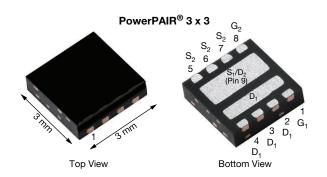








Dual N-Channel 30 V (D-S) MOSFET



PRODUCT SUMMARY						
MOSFET CHANNEL-1 AND CHANNEL-2						
V _{DS} (V)	30					
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 10 \text{ V}$	0.00675					
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 4.5 \text{ V}$	0.00944					
Q _g typ. (nC)	6.3					
I _D (A) ^{a, d}	30					
Configuration	Dual					

FEATURES





• High side and low side MOSFETs form optimized combination for 50 % duty cycle

COMPLIANT

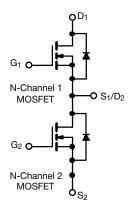
• Optimized R_{DS} - Q_g and R_{DS} - Q_{gd} FOM elevates efficiency for high frequency switching

HALOGEN FREE

- 100 % R_a and UIS tested
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Synchronous buck
- DC/DC conversion
- Half bridge
- POL



ORDERING INFORMATION	
Package	PowerPAIR 3 x 3
Lead (Pb)-free and halogen-free	SiZ350DT-T1-GE3

PARAMETER		CHANNEL-1 AND CHANNEL-2			
		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	30		
Gate-source voltage		V _{GS}	+16 / -12	V	
Continuous drain current (T _J = 150 °C)	T _C = 25 °C		30 a		
	T _C = 70 °C		30 a		
	T _A = 25 °C	I _D	18.5 ^{b, c}		
	T _A = 70 °C		14.8 b, c		
Pulsed drain current (t = 100 µs)		I _{DM}	100	Α	
	T _C = 25 °C		13.9		
Continuous source current (MOSFET diode conduction)	T _A = 25 °C	I _S	3.1 b, c		
Single pulse avalanche current	. 0.111	I _{AS}	10		
Single pulse avalanche energy	L = 0.1 mH	E _{AS}	5	mJ	
	T _C = 25 °C		16.7		
	T _C = 70 °C	5	10.7	\A/	
Maximum power dissipation	T _A = 25 °C	P _D	3.7 b, c	W	
	T _A = 70 °C		2.4 b, c		
Operating junction and storage temperature range	T _J , T _{stg}	-55 to +150			
Soldering recommendations (peak temperature)	Ŭ.	260	°C		

- a. Package limited
- b. Surface mounted on 1" x 1" FR4 board
- c. t = 10 s
- d. $T_C = 25$ °C



Vishay Siliconix

THERMAL RESISTANCE RATINGS						
PARAMETER		CHANNEL-1 AND CHANNEL-2				
		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum junction-to-ambient a, b	t ≤ 10 s	R _{thJA}	27	34	°C/W	
Maximum junction-to-case (drain)	Steady state	R _{thJC}	6	7.5	G/ VV	

Notes

- a. Surface mounted on 1" x 1" FR4 board
- b. Maximum under steady state conditions is 69 °C/W

DADAMETED	CHANNEL-1 AND CHANNEL-2						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	30	-	-	V	
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1	-	2.4	V	
Gate-source leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = +16 \text{ V} / -12 \text{ V}$	-	-	± 100	nA	
7	1	V _{DS} = 30 V, V _{GS} = 0 V	-	-	1	_	
Zero gate voltage drain current	I _{DSS}	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 \text{ °C}$	-	-	5	μA	
On-state drain current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	40	-	-	Α	
Drain aguras en etata registanas a	В	V _{GS} = 10 V, I _D = 15 A	-	0.00563	0.00675	Ω	
Drain-source on-state resistance ^a R _I	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 10 \text{ A}$	-	0.00787	0.00944		
Forward transconductance ^a	9 _{fs}	V _{DS} = 10 V, I _D = 15 A	=	46	-	S	
Dynamic ^b							
Input capacitance	C _{iss}	V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz	=	940	-	pF	
Output capacitance	C _{oss}		=	375	-		
Reverse transfer capacitance	C _{rss}		-	40	-		
C _{rss} /C _{iss} ratio			-	0.043	0.086		
Total gate charge	0	$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 18.5 \text{ A}$	= 15 V, V _{GS} = 10 V, I _D = 18.5 A - 13.5	13.5	20.3	nC	
Total gate charge	Q_g		-	6.3	10		
Gate-source charge	Q_{gs}	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 18.5 \text{ A}$	ı	2.8	-		
Gate-drain charge	Q_{gd}		-	1.2	-		
Gate resistance	R_{g}	f = 1 MHz	0.2	0.8	1.6	Ω	
Turn-on delay time	t _{d(on)}		ı	10	20	ns	
Rise time	t _r	$V_{DD} = 15 \text{ V}, R_L = 1 \Omega, I_D \cong 14.8 \text{ A},$	=	25	50		
Turn-off delay time	t _{d(off)}	$V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	=	15	30		
Fall time	t _f		=	10	20		
Turn-on delay time	t _{d(on)}	$V_{DD} = 15 \text{ V}, R_1 = 1 \Omega, I_D \cong 14.8 \text{ A},$	=	15	30		
Rise time	t _r		-	45	68		
Turn-off delay time	t _{d(off)}	$V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$	-	10	20		
Fall time	t _f	1	-	25	50		



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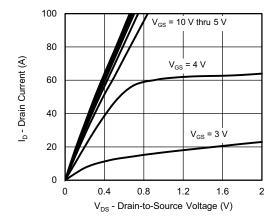
SPECIFICATIONS (T _J = 25 °C, unless otherwise noted)							
PARAMETER	CHANNEL-1 AND CHANNEL-2						
FANAIVIE I EN	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Drain-source Body Diode Characteristics							
Continuous source-drain diode current	I _S	T _C = 25°C -	-	13.9	^		
Pulse diode forward current	I _{SM}		-	-	100	Α	
Body diode voltage	V_{SD}	$I_S = 14.8 \text{ A}, V_{GS} = 0 \text{ V}$	-	0.85	1.2	V	
Body diode reverse recovery time	t _{rr}	I _F = 14.8 A, di/dt = 100 A/μs, T _J = 25 °C	-	30	45	ns	
Body diode reverse recovery charge	Q_{rr}		-	30	45	nC	
Reverse recovery fall time	ta		-	17	-	no	
Reverse recovery rise time	t _b		-	13	-	ns	

Notes

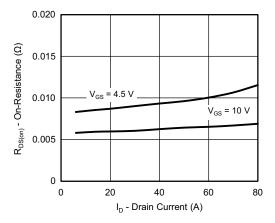
- a. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%$
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

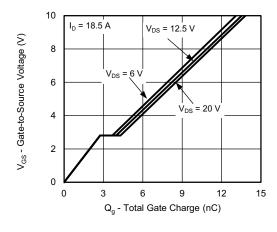




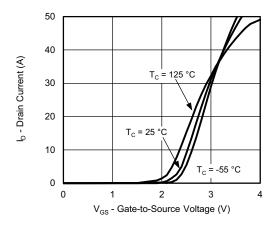
Output Characteristics



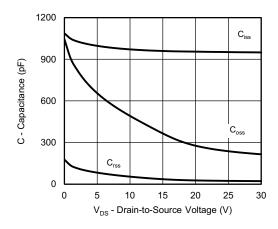
On-Resistance vs. Drain Current and Gate



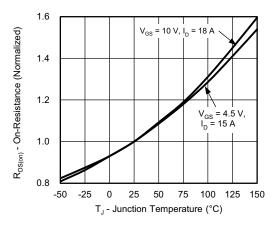
Gate Charge



Transfer Characteristics

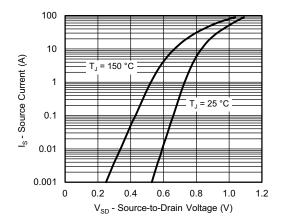


Capacitance

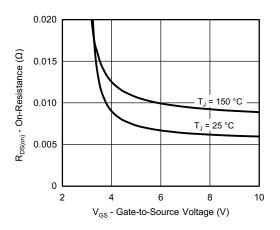


On-Resistance vs. Junction Temperature

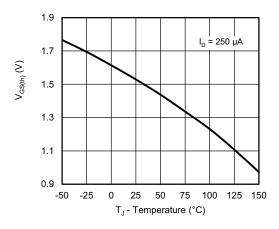




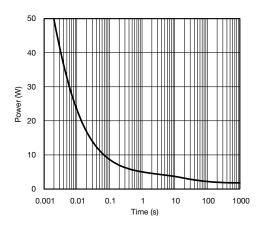
Source-Drain Diode Forward Voltage



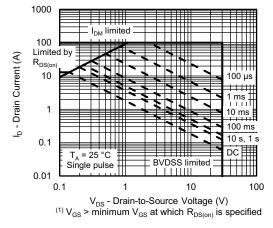
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage

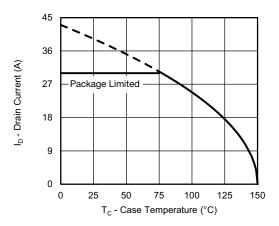


Single Pulse Power

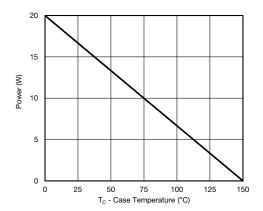


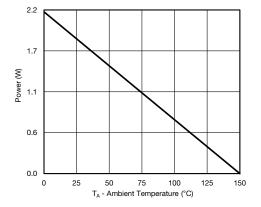
Safe Operating Area, Junction-to-Ambient





Current Derating a





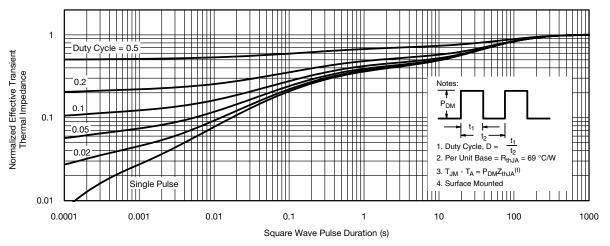
Power, Junction-to-Case

Power, Junction-to-Ambient

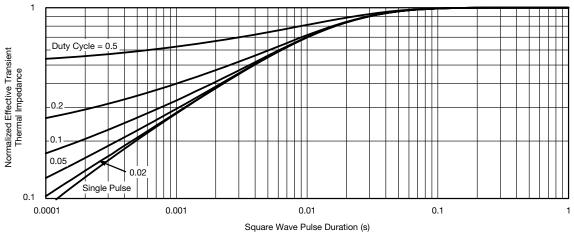
Note

a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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